

Ultra Fast Prototypes - Pre-production - Small Volume BGA -
Small Volume QFN (pre-plated leadframes) - MEMS -
System-in-package

BGA package offerings

Body Size	I/O	Ball Size	Ball Pitch
5x5	65	0.3mm	0.5mm
7x7	128	0.3mm	0.5mm
9x9	100	0.3mm	0.8mm
10x10	281	0.3mm	0.5mm
	128	0.3mm	0.8mm
12x12	169	0.4mm	0.8mm
	179	0.4mm	0.8mm
	196	0.4mm	0.8mm
14x14	208	0.3mm	0.8mm
15x15	256	0.4mm	0.8mm
19x19	300	0.5mm	1.0mm
	448	0.5mm	0.8mm
	529	0.5mm	0.8mm
23x23	641	0.4mm	0.8mm

QFN package offerings

Body Size	I/O	DAP Size	Lead Pitch
3x3	16	1.75x1.75mm	0.5mm
4x4	20	2.5x2.5mm	0.5mm
	24	2.5x2.5mm	0.5mm
5x5	28	3.5x3.5mm	0.5mm
	32	3.5x3.5mm	0.5mm
6x6	40	4.5x4.5mm	0.5mm
7x7	48	5.5x5.5mm	0.5mm
	56	5.5x5.5mm	0.4mm
8x8	56	6.5x6.5mm	0.5mm
9x9	64	7.3x7.3mm	0.5mm
10x10	68	8.2x8.2mm	0.5mm
	88	8.5x8.5mm	0.4mm